

**Amendments to the Specification:**

Please replace paragraph [0020] with the following rewritten paragraph:

[0020] In order to form the layer of the gap fill material from the gap fill material forming composition according to the present invention, baking is carried out. In this process, components having ~~law~~ low molecular weight abundantly contained in the composition cause a problem that an apparatus is polluted by sublimation of the components having ~~law~~ low molecular weight, or the like. Therefore, it is preferable that the components having ~~law~~ low molecular weight are contained in a small amount in the gap fill material forming composition according to the present invention. It is preferable to use a polymer containing components having a molecular weight of 3000 or less in a ratio of 20% or less, or in a ratio of 10% or less, as the polymer used in the gap fill material forming composition according to the present invention.